# 74HC32; 74HCT32

## Quad 2-input OR gate

Rev. 9 — 13 March 2024

#### **Product data sheet**

### 1. General description

The 74HC32; 74HCT32 is a quad 2-input OR gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{\rm CC}$ .

#### 2. Features and benefits

- Wide supply voltage range from 2.0 to 6.0 V
- CMOS low power dissipation
- · High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC32: CMOS level
  - For 74HCT32: TTL level
- · Symmetrical output impedance
- · Balanced propagation delays
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

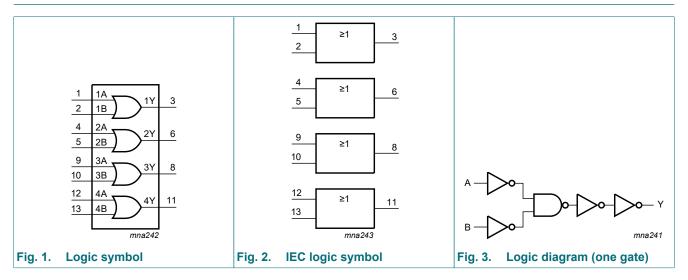
## 3. Ordering information

**Table 1. Ordering information** 

Type number				
	Temperature range	Name	Description	Version
74HC32D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1
74HCT32D			body width 3.9 mm	
74HC32PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package;	SOT402-1
74HCT32PW			14 leads; body width 4.4 mm	
74HC32BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal	SOT762-1
74HCT32BQ			enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	

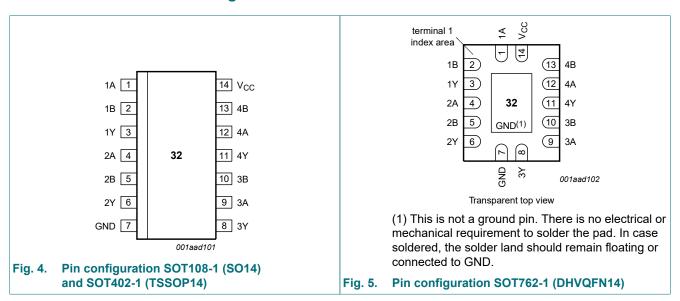


## 4. Functional diagram



## 5. Pinning information

#### 5.1. Pinning



#### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 4A	1, 4, 9, 12	data input
1B to 4B	2, 5, 10,13	data input
1Y to 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V <sub>CC</sub>	14	supply voltage

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## 6. Functional description

#### **Table 3. Function table**

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care.$ 

Input	Output	
nA	nB	nY
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

## 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
Io	output current	-0.5 V < V <sub>O</sub> < V <sub>CC</sub> + 0.5 V	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[2]	-	500	mW

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC32		74HCT32			Unit	
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
V <sub>O</sub>	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

<sup>[2]</sup> For SOT108-1 (SO14) package: Ptot derates linearly with 10.1 mW/K above 100 °C.

For SOT402-1 (TSSOP14) package: Ptot derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package: Ptot derates linearly with 9.6 mW/K above 98 °C.

## 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC32	-									
V <sub>IH</sub> HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V	
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 2.0 V	-	8.0	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	٧
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT3	2			ı						
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	8.0	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V								
-	output voltage	Ι <sub>O</sub> = 20 μΑ	-	0	0.1	-	0.1	-	0.1	٧
		I <sub>O</sub> = 5.2 mA	-	0.15	0.25	-	0.33	-	0.4	V

Symbol	Parameter	eter Conditions 25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit	
			Min	Тур	Max	Min	Max	Min	Max	
II	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	2.0	-	20	-	40	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to $5.5 \text{ V}$	-	-	430	-	540	-	590	μА
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

## 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

GND = 0 V;  $C_L$  = 50 pF; for test circuit see Fig. 7.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC32	<u>'</u>									
t <sub>pd</sub>	propagation	nA, nB to nY; see Fig. 6 [1]								
	delay	V <sub>CC</sub> = 2.0 V	-	22	90	-	115	-	135	ns
		V <sub>CC</sub> = 4.5 V	-	8	18	-	23	-	27	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	6	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	6	15	-	20	-	23	ns
t <sub>t</sub>	transition	see Fig. 6 [2]								
	time	V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
C <sub>PD</sub>	power dissipation capacitance	per package; [3] $V_I = GND \text{ to } V_{CC}$	-	16	-	-	-	-	-	pF
74HCT3	2						1			
t <sub>pd</sub>	propagation	nA, nB to nY; see Fig. 6 [1]								
	delay	V <sub>CC</sub> = 4.5 V	-	11	24	-	30	-	36	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	9	-	-	-	-	-	ns
t <sub>t</sub>	transition time	V <sub>CC</sub> = 4.5 V; see <u>Fig. 6</u> [2]	-	7	15	-	19	-	22	ns
C <sub>PD</sub>	power dissipation capacitance	per package; [3] V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	-	28	-	-	-	-	-	pF

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

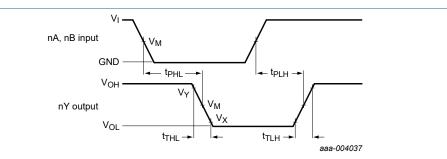
f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz;

 $C_L$  = output load capacitance in pF;  $V_{CC}$  = supply voltage in V; N = number of inputs switching;

 $\Sigma$  (C<sub>L</sub> × V<sub>CC</sub>  $^2$  × f<sub>o</sub>) = sum of outputs.

 $<sup>\</sup>begin{array}{ll} [1] & t_{pd} \text{ is the same as } t_{PHL} \text{ and } t_{PLH}. \\ [2] & t_{t} \text{ is the same as } t_{THL} \text{ and } t_{TLH}. \\ [3] & C_{PD} \text{ is used to determine the dynamic power dissipation } (P_{D} \text{ in } \mu\text{W}): \end{array}$ 

#### 10.1. Waveforms and test circuit



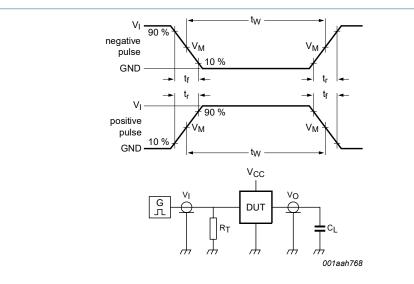
Measurement points are given in Table 8.

 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Fig. 6. Input to output propagation delays and output transition times

**Table 8. Measurement points** 

Туре	Input	Output					
	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
74HC32	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			
74HCT32	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub> = load capacitance including jig and probe capacitance.

Fig. 7. Test circuit for measuring switching times

Table 9. Test data

Туре	Input L		Load	Test
	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC32	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT32	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

## 11. Package outline

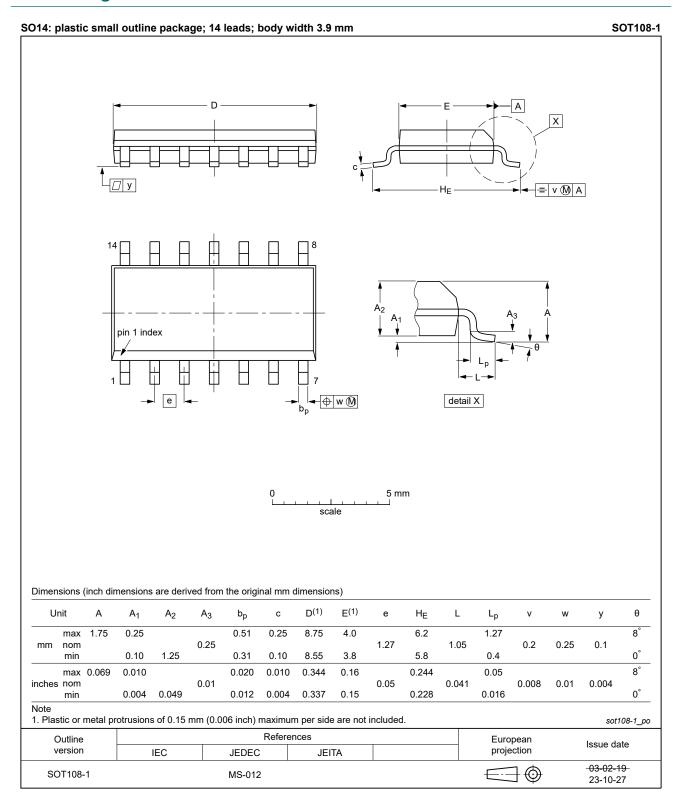


Fig. 8. Package outline SOT108-1 (SO14)

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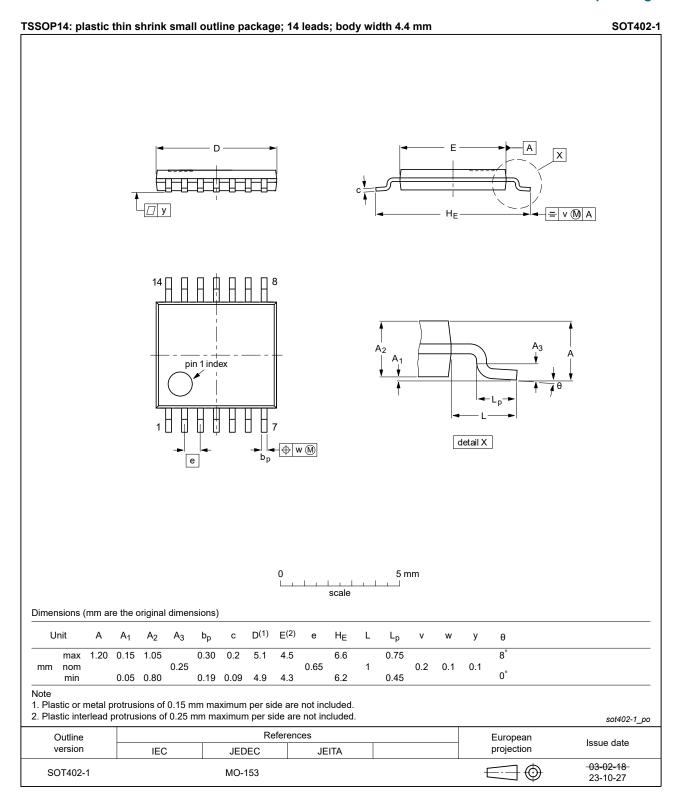


Fig. 9. Package outline SOT402-1 (TSSOP14)

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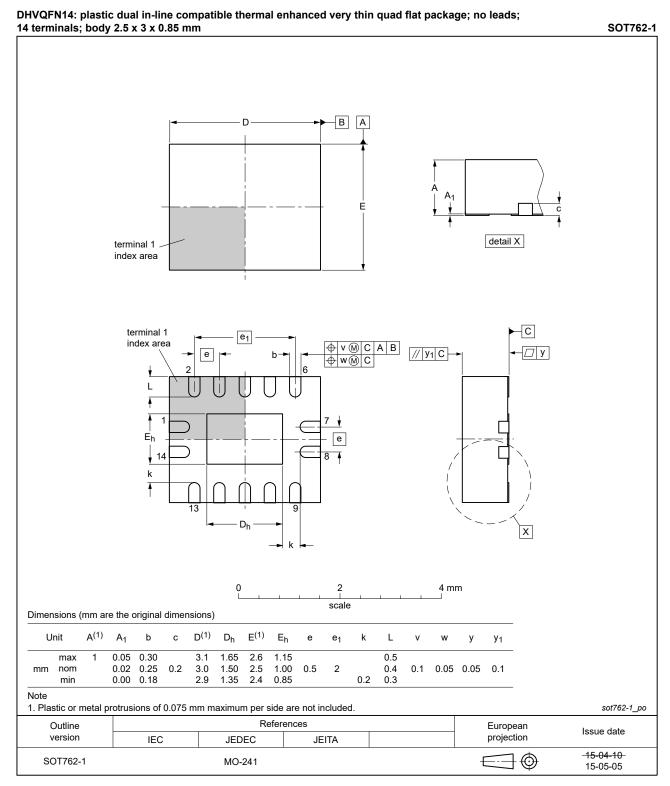


Fig. 10. Package outline SOT762-1 (DHVQFN14)

## 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

## 13. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
74HC_HCT32 v.9	20240313	Product data sheet	-	74HC_HCT32 v.8		
Modifications:		•	•	atest JEDEC standard. Ine drawings to JEDEC MS-012		
74HC_HCT32 v.8	20210730	Product data sheet	-	74HC_HCT32 v.7		
Modifications:	<ul><li>Type numb</li><li>Section 2 u</li></ul>	ers 74HC32DB and 74HC pdated.	T32DB (SOT337-1	I/SSOP16) removed.		
74HC_HCT32 v.7	20190930	Product data sheet	-	74HC_HCT32 v.6		
Modifications:	guidelines of Legal texts	of this data sheet has bee of Nexperia. have been adapted to the rating values for P <sub>tot</sub> total p	new company nar	me where appropriate.		
74HC_HCT32 v.6	20151203	Product data sheet	-	74HC_HCT32 v.5		
Modifications:	Type number	ers 74HC32N and 74HCT	32N (SOT27-1) rei	moved.		
74HC_HCT32 v.5	20120904	Product data sheet	-	74HC_HCT32 v.4		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines         of NXP Semiconductors.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
74HC_HCT32 v.4	20031212	Product specification	-	74HC_HCT32 v.3		
74HC_HCT32 v.3	20030829	Product specification	-	74HC_HCT32_CNV v.2		
74HC_HCT32_CNV v.2	19970827	Product specification	-	-		

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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